

MOSFET

OptiMOS™ 5 Power-Transistor, 25 V

Features

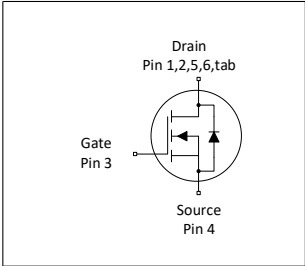
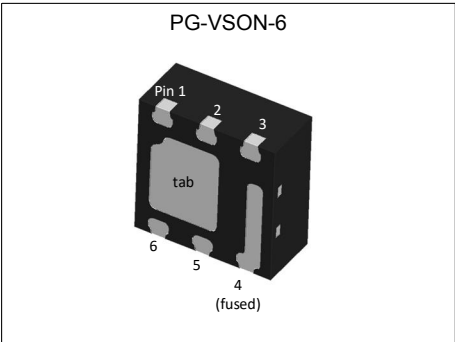
- Lowest on-resistance  $R_{DS(on)}$  in a 2x2 package
- Superior thermal resistance for a 2x2 package
- Optimized for highest performance and power density
- 100% avalanche tested
- N-channel
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21

Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 Key Performance Parameters

| Parameter        | Value | Unit |
|------------------|-------|------|
| $V_{DS}$         | 25    | V    |
| $R_{DS(on),max}$ | 2.4   | mΩ   |
| $I_D$            | 103   | A    |
| $Q_{oss}$        | 9.3   | nC   |
| $Q_G(0V..4.5V)$  | 6.5   | nC   |



RoHS

| Type / Ordering Code | Package   | Marking | Related Links |
|----------------------|-----------|---------|---------------|
| ISK024NE2LM5         | PG-VSON-6 | 24E2    | -             |

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## 1 Maximum ratings

at  $T_A=25\text{ °C}$ , unless otherwise specified

**Table 2 Maximum ratings**

| Parameter                                    | Symbol            | Values |      |                 | Unit | Note / Test Condition                                                                                                                                                  |
|----------------------------------------------|-------------------|--------|------|-----------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                                              |                   | Min.   | Typ. | Max.            |      |                                                                                                                                                                        |
| Continuous drain current <sup>1)</sup>       | $I_D$             | -      | -    | 103<br>65<br>20 | A    | $V_{GS}=10\text{ V}$ , $T_C=25\text{ °C}$<br>$V_{GS}=10\text{ V}$ , $T_C=100\text{ °C}$<br>$V_{GS}=4.5\text{ V}$ , $T_A=25\text{ °C}$ , $R_{thJA}=60\text{ °C/W}^{2)}$ |
| Pulsed drain current <sup>3)</sup>           | $I_{D,pulse}$     | -      | -    | 410             | A    | $T_A=25\text{ °C}$                                                                                                                                                     |
| Avalanche energy, single pulse <sup>4)</sup> | $E_{AS}$          | -      | -    | 7               | mJ   | $I_D=20\text{ A}$ , $R_{GS}=25\text{ }\Omega$                                                                                                                          |
| Gate source voltage                          | $V_{GS}$          | -16    | -    | 16              | V    | -                                                                                                                                                                      |
| Power dissipation                            | $P_{tot}$         | -      | -    | 39<br>2.1       | W    | $T_C=25\text{ °C}$<br>$T_A=25\text{ °C}$ , $R_{thJA}=60\text{ °C/W}^{2)}$                                                                                              |
| Operating and storage temperature            | $T_j$ , $T_{stg}$ | -55    | -    | 150             | °C   | -                                                                                                                                                                      |

## 2 Thermal characteristics

at  $T_j=25\text{ °C}$ , unless otherwise specified

**Table 3 Thermal characteristics**

| Parameter                                                   | Symbol     | Values |      |      | Unit | Note / Test Condition |
|-------------------------------------------------------------|------------|--------|------|------|------|-----------------------|
|                                                             |            | Min.   | Typ. | Max. |      |                       |
| Thermal resistance, junction - case, bottom                 | $R_{thJC}$ | -      | 1.6  | 3.2  | °C/W | -                     |
| Device on PCB, 6 cm <sup>2</sup> cooling area <sup>2)</sup> | $R_{thJA}$ | -      | -    | 60   | °C/W | -                     |

<sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

<sup>2)</sup> Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

<sup>3)</sup> See Diagram 3 for more detailed information

<sup>4)</sup> See Diagram 13 for more detailed information

### 3 Electrical characteristics

at  $T_j=25\text{ °C}$ , unless otherwise specified

**Table 4 Static characteristics**

| Parameter                        | Symbol        | Values |            |            | Unit          | Note / Test Condition                                                                                                               |
|----------------------------------|---------------|--------|------------|------------|---------------|-------------------------------------------------------------------------------------------------------------------------------------|
|                                  |               | Min.   | Typ.       | Max.       |               |                                                                                                                                     |
| Drain-source breakdown voltage   | $V_{(BR)DSS}$ | 25     | -          | -          | V             | $V_{GS}=0\text{ V}$ , $I_D=1\text{ mA}$                                                                                             |
| Gate threshold voltage           | $V_{GS(th)}$  | 1.2    | 1.6        | 2.0        | V             | $V_{DS}=V_{GS}$ , $I_D=250\text{ }\mu\text{A}$                                                                                      |
| Zero gate voltage drain current  | $I_{DSS}$     | -      | 0.1<br>10  | 1<br>100   | $\mu\text{A}$ | $V_{DS}=20\text{ V}$ , $V_{GS}=0\text{ V}$ , $T_j=25\text{ °C}$<br>$V_{DS}=20\text{ V}$ , $V_{GS}=0\text{ V}$ , $T_j=125\text{ °C}$ |
| Gate-source leakage current      | $I_{GSS}$     | -      | 10         | 100        | nA            | $V_{GS}=16\text{ V}$ , $V_{DS}=0\text{ V}$                                                                                          |
| Drain-source on-state resistance | $R_{DS(on)}$  | -      | 2.0<br>2.7 | 2.4<br>3.4 | m $\Omega$    | $V_{GS}=10\text{ V}$ , $I_D=20\text{ A}$<br>$V_{GS}=4.5\text{ V}$ , $I_D=20\text{ A}$                                               |
| Gate resistance <sup>1)</sup>    | $R_G$         | -      | 0.7        | 1.2        | $\Omega$      | -                                                                                                                                   |
| Transconductance                 | $g_{fs}$      | -      | 98         | -          | S             | $ V_{DS} \geq 2 I_D /R_{DS(on)max}$ , $I_D=20\text{ A}$                                                                             |

**Table 5 Dynamic characteristics**

| Parameter                                  | Symbol       | Values |      |      | Unit | Note / Test Condition                                                                              |
|--------------------------------------------|--------------|--------|------|------|------|----------------------------------------------------------------------------------------------------|
|                                            |              | Min.   | Typ. | Max. |      |                                                                                                    |
| Input capacitance <sup>1)</sup>            | $C_{iss}$    | -      | 930  | 1200 | pF   | $V_{GS}=0\text{ V}$ , $V_{DS}=12\text{ V}$ , $f=1\text{ MHz}$                                      |
| Output capacitance <sup>1)</sup>           | $C_{oss}$    | -      | 400  | 520  | pF   | $V_{GS}=0\text{ V}$ , $V_{DS}=12\text{ V}$ , $f=1\text{ MHz}$                                      |
| Reverse transfer capacitance <sup>1)</sup> | $C_{rss}$    | -      | 39   | 68   | pF   | $V_{GS}=0\text{ V}$ , $V_{DS}=12\text{ V}$ , $f=1\text{ MHz}$                                      |
| Turn-on delay time                         | $t_{d(on)}$  | -      | 7.2  | -    | ns   | $V_{DD}=12\text{ V}$ , $V_{GS}=10\text{ V}$ , $I_D=20\text{ A}$ ,<br>$R_{G,ext}=1.6\text{ }\Omega$ |
| Rise time                                  | $t_r$        | -      | 1.6  | -    | ns   | $V_{DD}=12\text{ V}$ , $V_{GS}=10\text{ V}$ , $I_D=20\text{ A}$ ,<br>$R_{G,ext}=1.6\text{ }\Omega$ |
| Turn-off delay time                        | $t_{d(off)}$ | -      | 14.6 | -    | ns   | $V_{DD}=12\text{ V}$ , $V_{GS}=10\text{ V}$ , $I_D=20\text{ A}$ ,<br>$R_{G,ext}=1.6\text{ }\Omega$ |
| Fall time                                  | $t_f$        | -      | 1.6  | -    | ns   | $V_{DD}=12\text{ V}$ , $V_{GS}=10\text{ V}$ , $I_D=20\text{ A}$ ,<br>$R_{G,ext}=1.6\text{ }\Omega$ |

**Table 6 Gate charge characteristics<sup>2)</sup>**

| Parameter                | Symbol        | Values |      |      | Unit | Note / Test Condition                                                        |
|--------------------------|---------------|--------|------|------|------|------------------------------------------------------------------------------|
|                          |               | Min.   | Typ. | Max. |      |                                                                              |
| Gate to source charge    | $Q_{gs}$      | -      | 2.3  | 3.0  | nC   | $V_{DD}=12\text{ V}$ , $I_D=20\text{ A}$ , $V_{GS}=0\text{ to }4.5\text{ V}$ |
| Gate charge at threshold | $Q_{g(th)}$   | -      | 1.5  | 2.0  | nC   | $V_{DD}=12\text{ V}$ , $I_D=20\text{ A}$ , $V_{GS}=0\text{ to }4.5\text{ V}$ |
| Gate to drain charge     | $Q_{gd}$      | -      | 1.4  | 2.1  | nC   | $V_{DD}=12\text{ V}$ , $I_D=20\text{ A}$ , $V_{GS}=0\text{ to }4.5\text{ V}$ |
| Switching charge         | $Q_{sw}$      | -      | 2.2  | 3.2  | nC   | $V_{DD}=12\text{ V}$ , $I_D=20\text{ A}$ , $V_{GS}=0\text{ to }4.5\text{ V}$ |
| Gate charge total        | $Q_g$         | -      | 6.5  | 9.7  | nC   | $V_{DD}=12\text{ V}$ , $I_D=20\text{ A}$ , $V_{GS}=0\text{ to }4.5\text{ V}$ |
| Gate plateau voltage     | $V_{plateau}$ | -      | 2.4  | -    | V    | $V_{DD}=12\text{ V}$ , $I_D=20\text{ A}$ , $V_{GS}=0\text{ to }4.5\text{ V}$ |
| Gate charge total        | $Q_g$         | -      | 14.0 | 18.6 | nC   | $V_{DD}=12\text{ V}$ , $I_D=20\text{ A}$ , $V_{GS}=0\text{ to }10\text{ V}$  |
| Output charge            | $Q_{oss}$     | -      | 9.3  | 12.4 | nC   | $V_{DD}=12\text{ V}$ , $V_{GS}=0\text{ V}$                                   |

<sup>1)</sup> Defined by design. Not subject to production test.

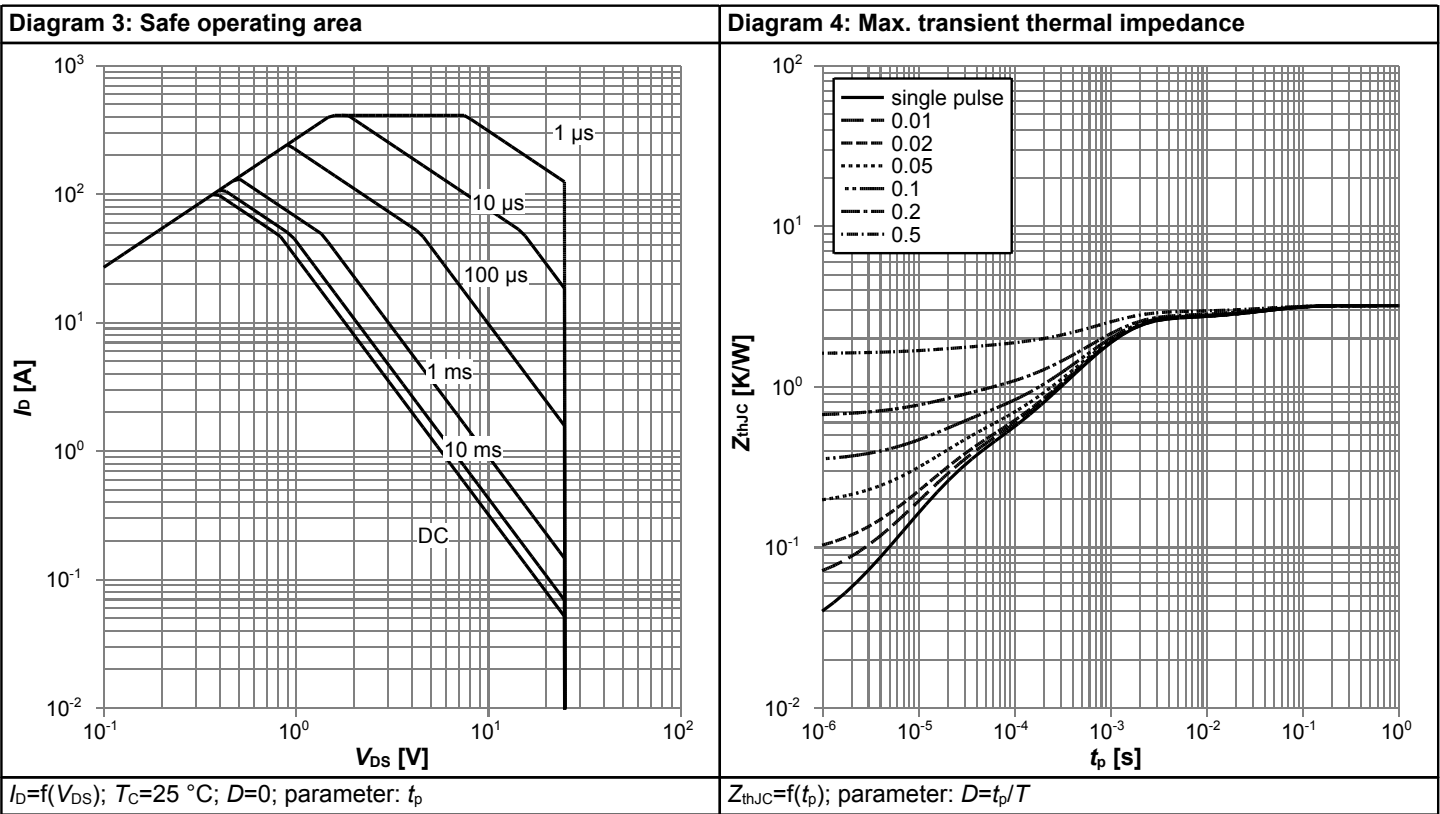
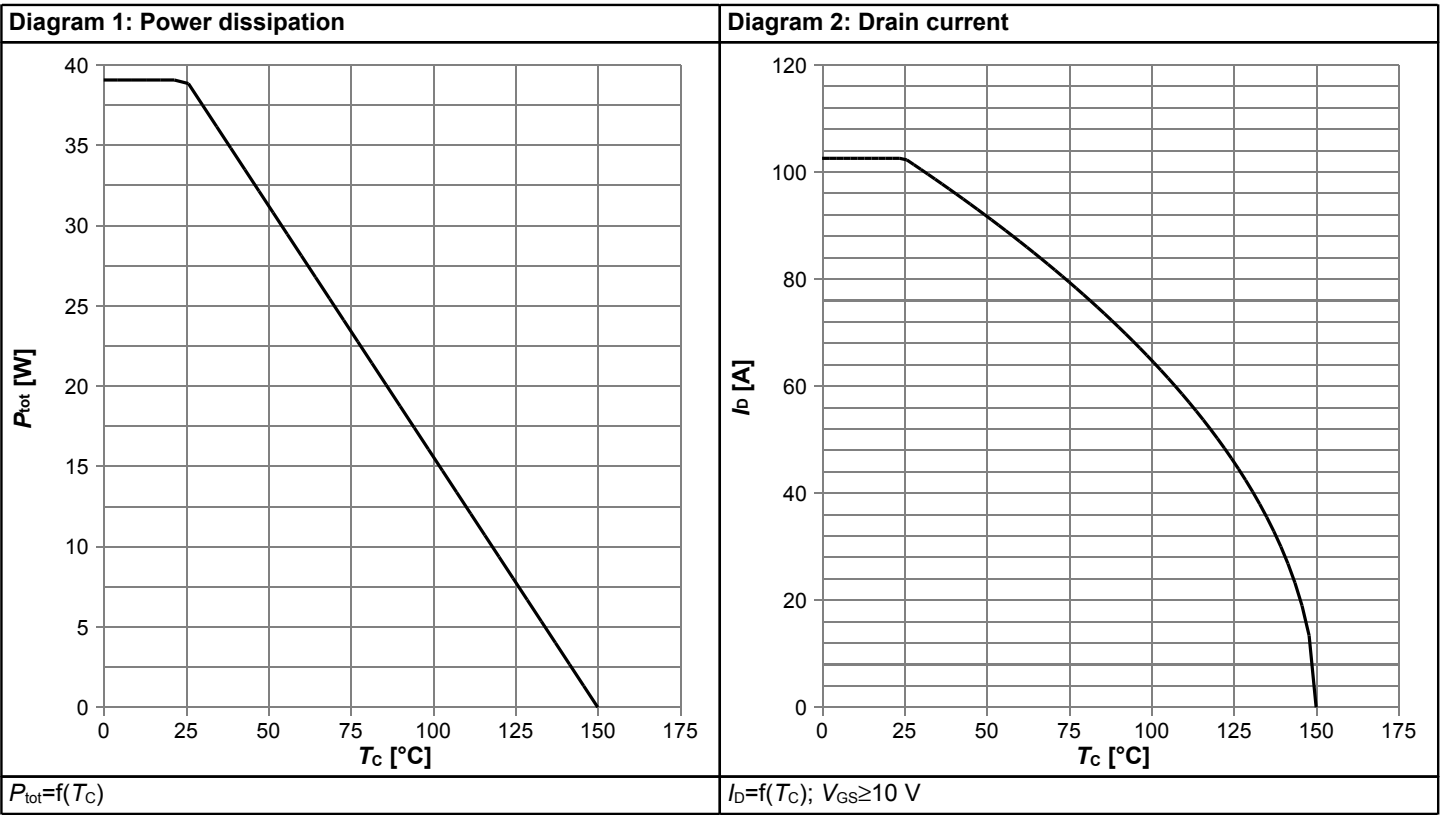
<sup>2)</sup> See figure 16 for gate charge parameter definition. Defined by design, not subject to production test

**Table 7 Reverse diode**

| Parameter                             | Symbol        | Values |      |      | Unit | Note / Test Condition                                                      |
|---------------------------------------|---------------|--------|------|------|------|----------------------------------------------------------------------------|
|                                       |               | Min.   | Typ. | Max. |      |                                                                            |
| Diode continuous forward current      | $I_S$         | -      | -    | 37   | A    | $T_C=25\text{ °C}$                                                         |
| Diode pulse current                   | $I_{S,pulse}$ | -      | -    | 410  | A    | $T_C=25\text{ °C}$                                                         |
| Diode forward voltage                 | $V_{SD}$      | -      | 0.81 | 1.0  | V    | $V_{GS}=0\text{ V}$ , $I_F=20\text{ A}$ , $T_j=25\text{ °C}$               |
| Reverse recovery time <sup>1)</sup>   | $t_{rr}$      | -      | 23.6 | 47.2 | ns   | $V_R=12\text{ V}$ , $I_F=20\text{ A}$ , $di_F/dt=100\text{ A}/\mu\text{s}$ |
| Reverse recovery charge <sup>1)</sup> | $Q_{rr}$      | -      | 15.2 | 30.4 | nC   | $V_R=12\text{ V}$ , $I_F=20\text{ A}$ , $di_F/dt=100\text{ A}/\mu\text{s}$ |

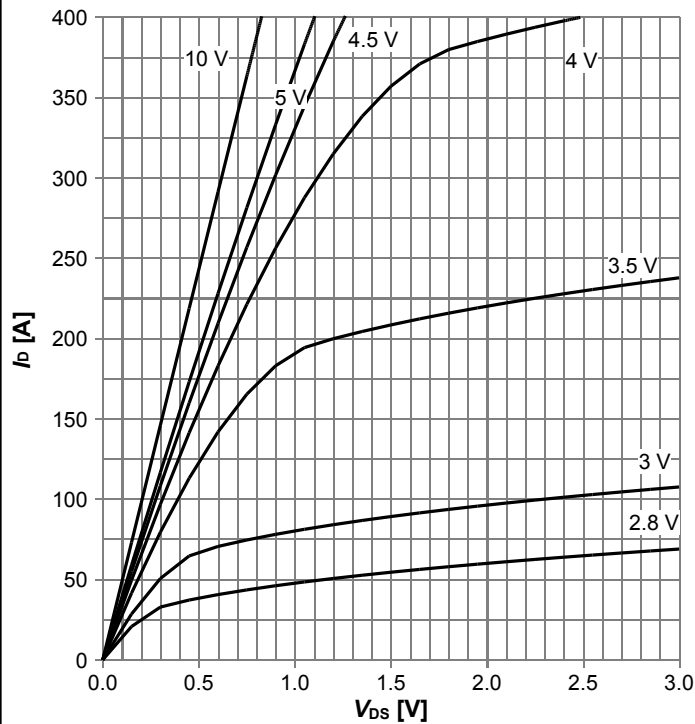
<sup>1)</sup> Defined by design. Not subject to production test.

# 4 Electrical characteristics diagrams



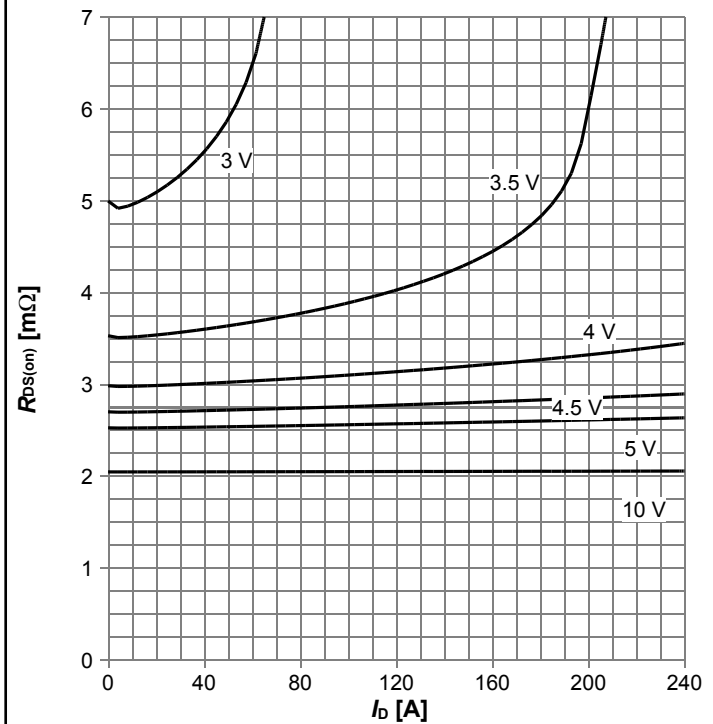
OptiMOS™ 5 Power-Transistor, 25 V  
ISK024NE2LM5

Diagram 5: Typ. output characteristics



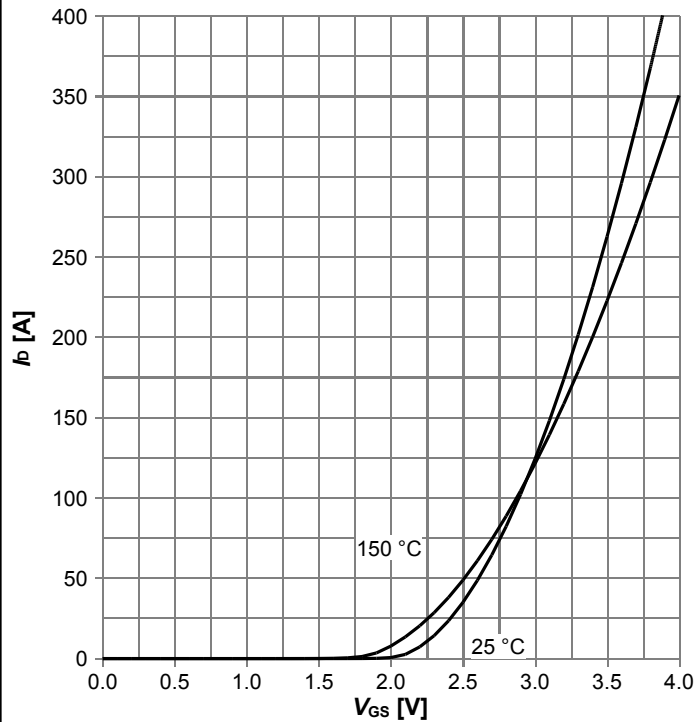
$I_D = f(V_{DS})$ ,  $T_j = 25^\circ\text{C}$ ; parameter:  $V_{GS}$

Diagram 6: Typ. drain-source on resistance



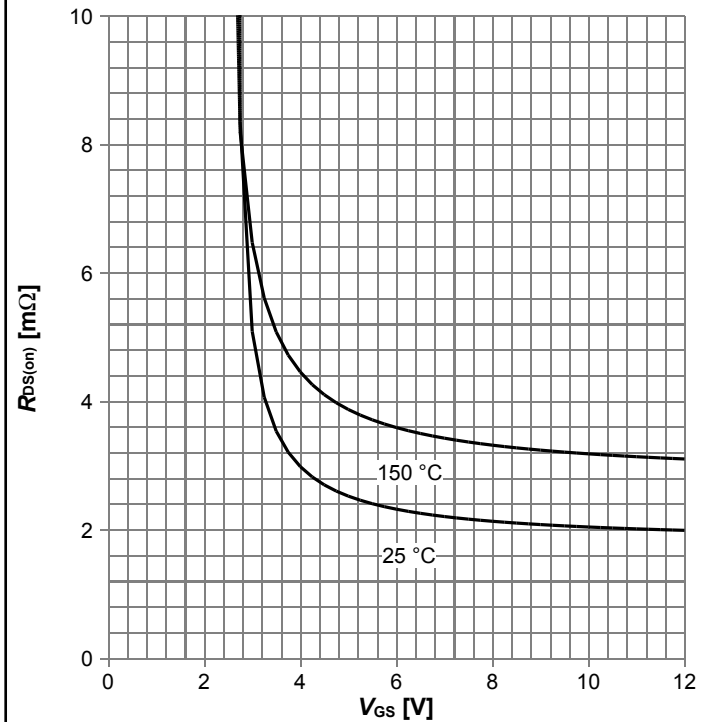
$R_{DS(on)} = f(I_D)$ ,  $T_j = 25^\circ\text{C}$ ; parameter:  $V_{GS}$

Diagram 7: Typ. transfer characteristics



$I_D = f(V_{GS})$ ,  $|V_{DS}| > 2|I_D|R_{DS(on)\max}$ ; parameter:  $T_j$

Diagram 8: Typ. drain-source on resistance



$R_{DS(on)} = f(V_{GS})$ ,  $I_D = 20\text{ A}$ ; parameter:  $T_j$

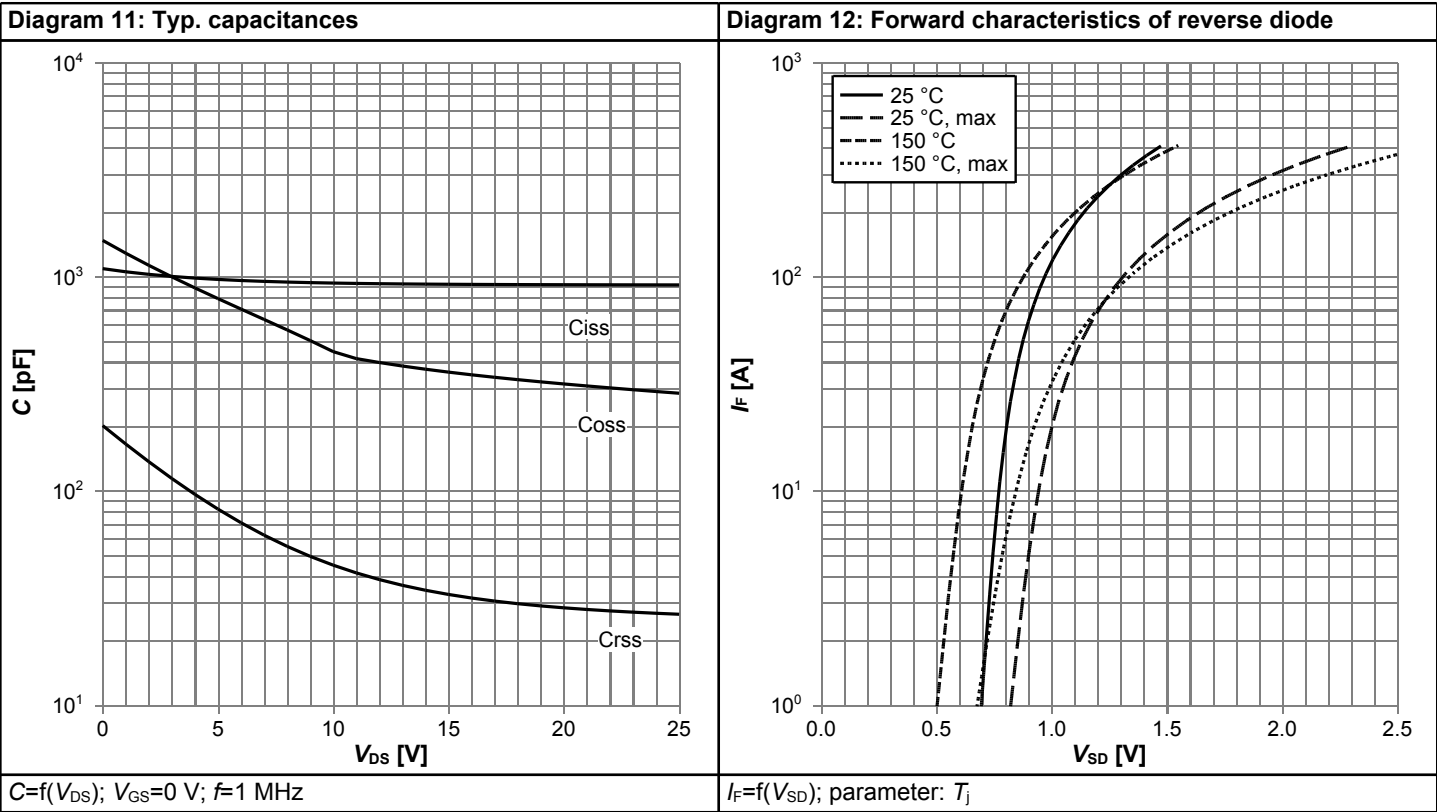
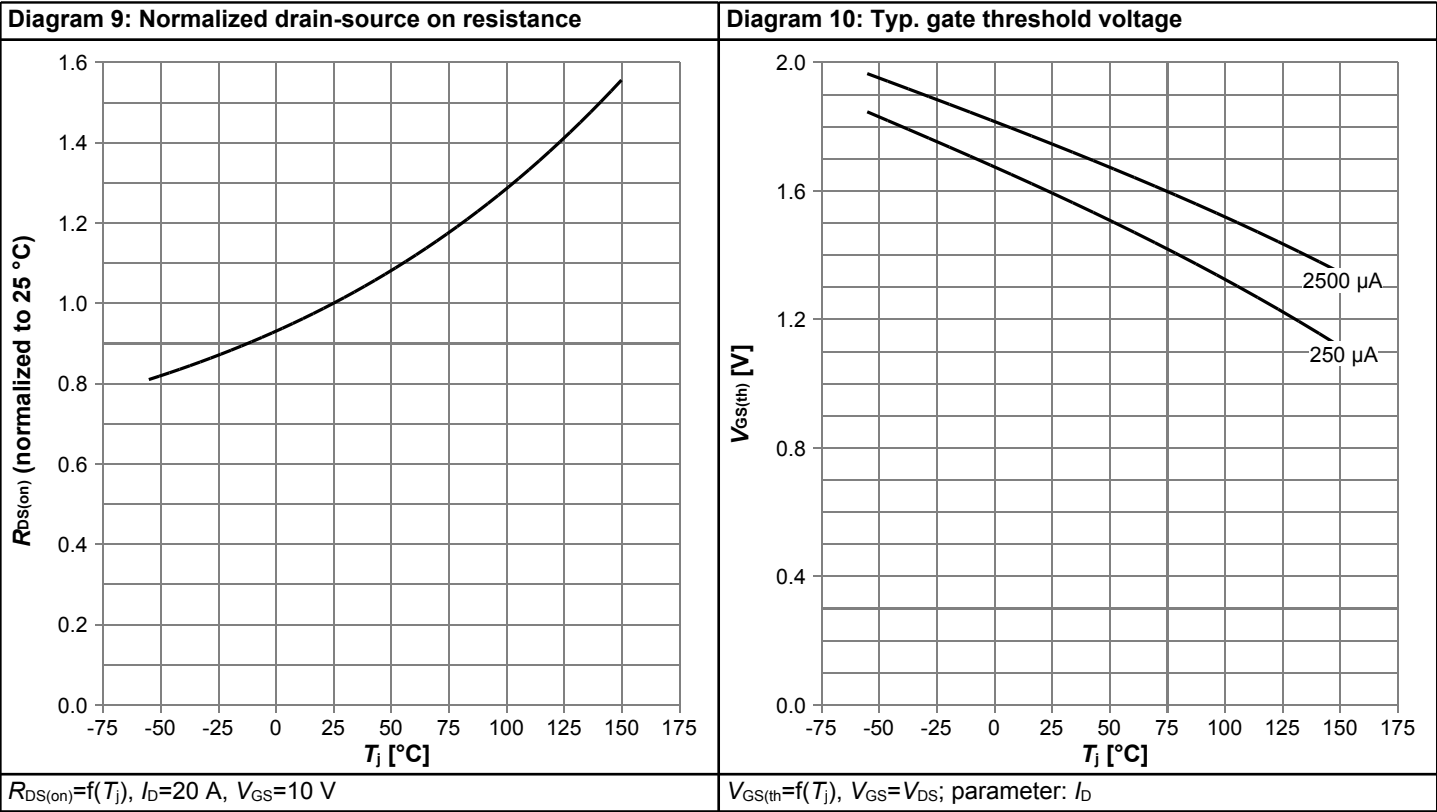
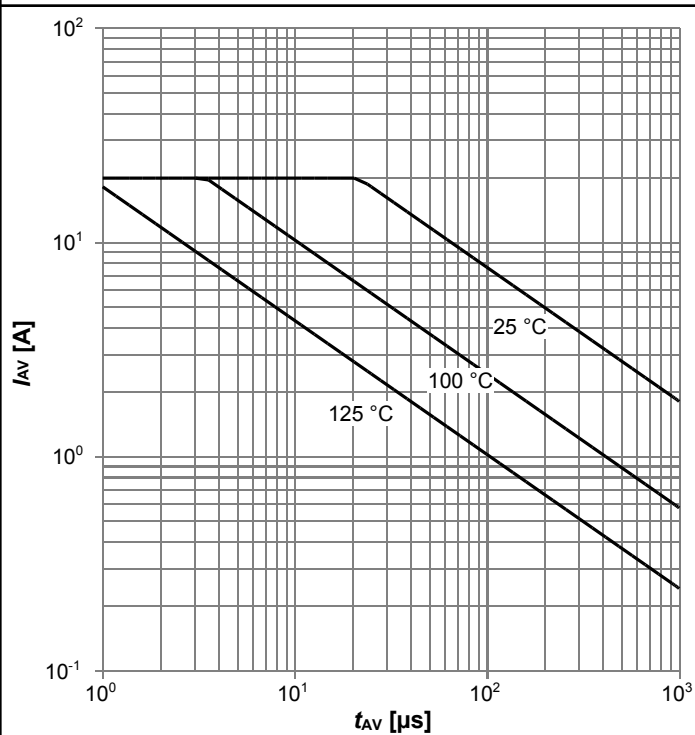
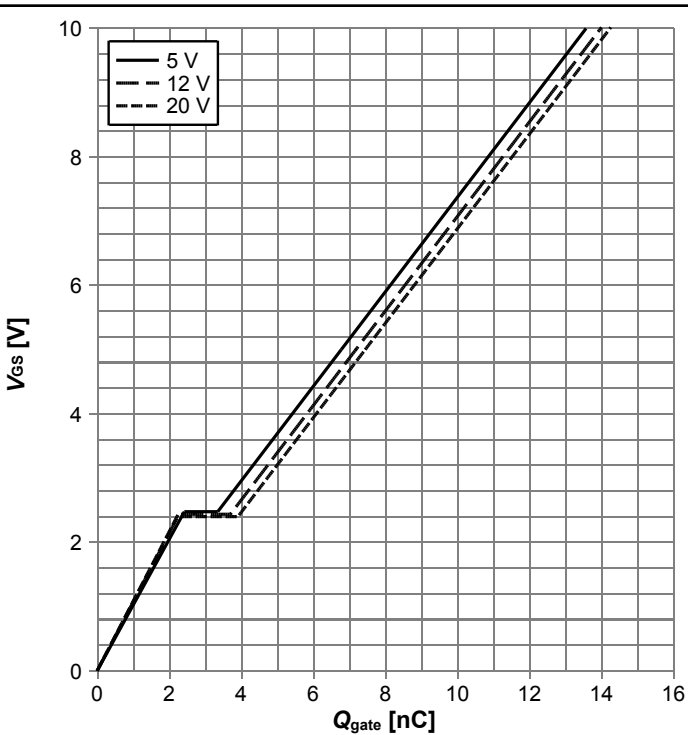


Diagram 13: Avalanche characteristics



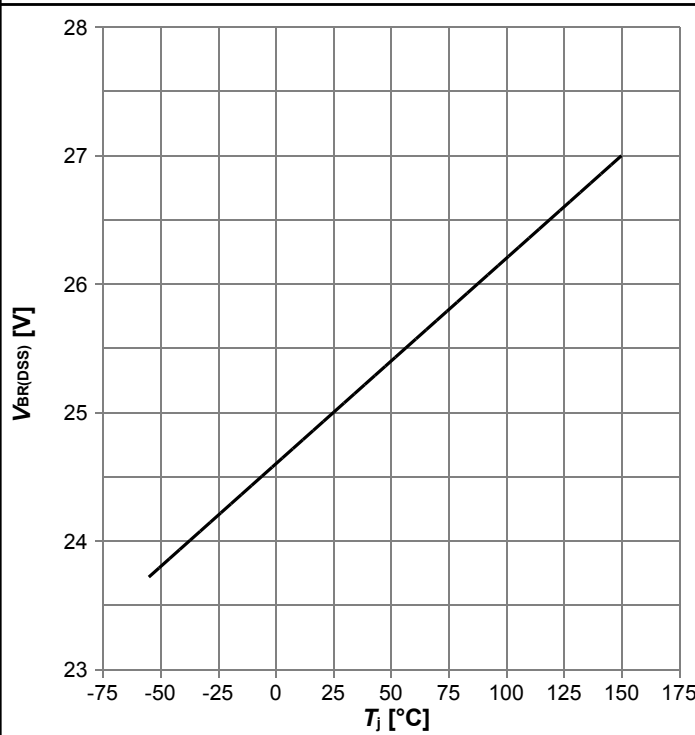
$I_{AS}=f(t_{AV})$ ;  $R_{GS}=25\ \Omega$ ; parameter:  $T_{j,start}$

Diagram 14: Typ. gate charge



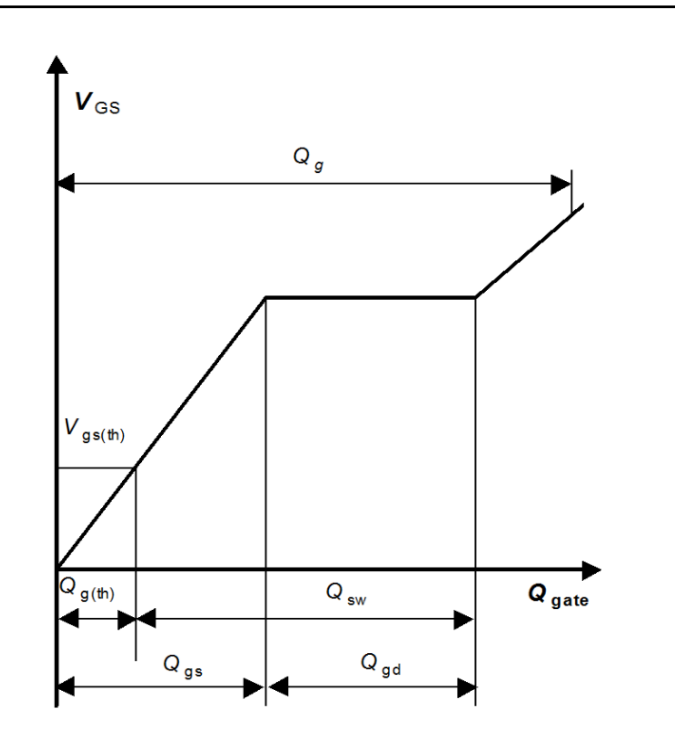
$V_{GS}=f(Q_{gate})$ ,  $I_D=20$  A pulsed,  $T_j=25\ ^\circ\text{C}$ ; parameter:  $V_{DD}$

Diagram 15: Min. drain-source breakdown voltage

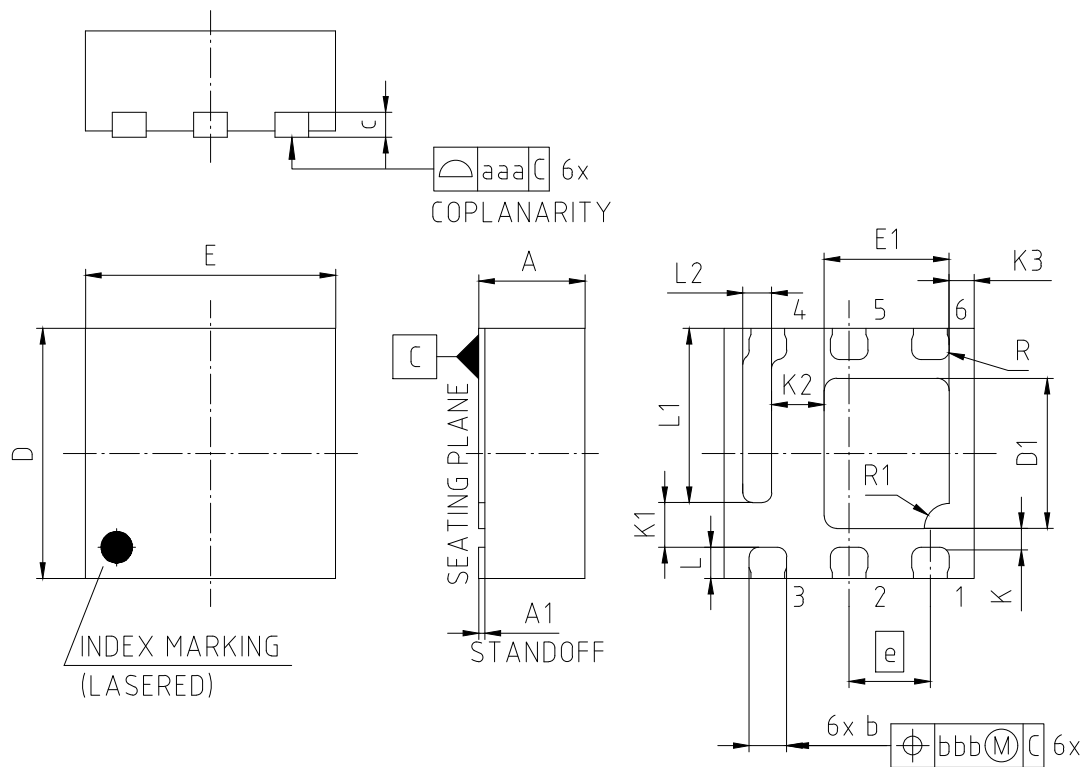


$V_{BR(DSS)}=f(T_j)$ ;  $I_D=1$  mA

Diagram Gate charge waveforms



# 5 Package Outlines



| PACKAGE - GROUP NUMBER: PG-VSON-6-U02 |             |      |            |             |      |
|---------------------------------------|-------------|------|------------|-------------|------|
| DIMENSIONS                            | MILLIMETERS |      | DIMENSIONS | MILLIMETERS |      |
|                                       | MIN.        | MAX. |            | MIN.        | MAX. |
| A                                     | ---         | 0.90 | L          | 0.20        | 0.30 |
| A1                                    | ---         | 0.05 | L1         | 1.29        | 1.49 |
| b                                     | 0.20        | 0.40 | L2         | 0.13        | 0.33 |
| c                                     | (0.20)      |      | R          | (0.08)      |      |
| D                                     | 1.90        | 2.10 | R1         | (0.20)      |      |
| D1                                    | 1.10        | 1.30 | N          | 6           |      |
| E                                     | 1.90        | 2.10 | aaa        | 0.08        |      |
| E1                                    | 0.90        | 1.10 | bbb        | 0.10        |      |
| e                                     | 0.65        |      |            |             |      |
| K                                     | 0.05        | ---  |            |             |      |
| K1                                    | 0.26        | ---  |            |             |      |
| K2                                    | 0.42        | ---  |            |             |      |
| K3                                    | 0.10        | 0.30 |            |             |      |

NOTE:  
DIMENSIONS DO NOT INCLUDE MOLD FLASH, PROTRUSION OR GATE BURRS

Figure 1 Outline PG-VSON-6, dimensions in mm

## Revision History

ISK024NE2LM5

**Revision: 2024-01-08, Rev. 2.2**

Previous Revision

| Revision | Date       | Subjects (major changes since last revision)                                       |
|----------|------------|------------------------------------------------------------------------------------|
| 2.0      | 2020-09-14 | Release of final version                                                           |
| 2.1      | 2023-06-05 | Update RthJC, current rating, Ptot, Rds(on)typ, Gfs, Capacitances and Gate charges |
| 2.2      | 2024-01-08 | Update POD                                                                         |

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